32-bit bus transceiver with direction pin; 5 V tolerant; 3-stateRev. 5 — 15 December 2011Product data sheet

1. General description

The 74LVCH32245A is a 32-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features four output enable ($n\overline{OE}$) inputs for easy cascading and four send/receive (nDIR) inputs for direction control. Pin $n\overline{OE}$ controls the outputs so that the buses are effectively isolated.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

To ensure the high-impedance state during power-up or power-down, pin $n\overline{OE}$ should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 2.3 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when V_{CC} = 0 V
- All data inputs have bus hold
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Packaged in plastic fine-pitch ball grid array package



32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

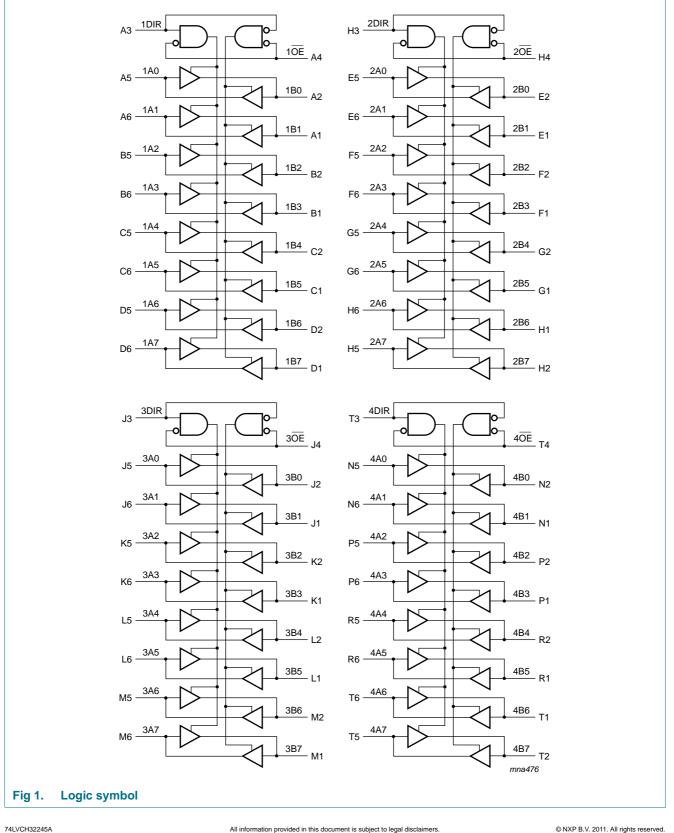
Ordering information 3.

Table 1. Ordering information										
Type number	Package									
	Temperature range	Name	Description	Version						
74LVCH32245AEC	–40 °C to +125 °C	LFBGA96	plastic low profile fine-pitch ball grid array package; 96 balls; body $13.5 \times 5.5 \times 1.05$ mm	SOT536-1						

74LVCH32245A **Product data sheet**

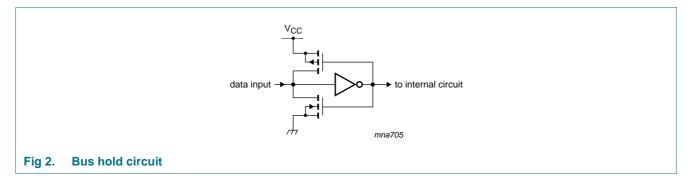
32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Functional diagram 4.



74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state



5. Pinning information

																r	nna475
	6	1A1	1A3	1A5	1A7	2A1	2A3	2A5	2A6	3A1	3A3	3A5	3A7	4A1	4A3	4A5	4A6
	5	1A0	1A2	1A4	1A6	2A0	2A2	2A4	2A7	3A0	3A2	3A4	3A6	4A0	4A2	4A4	4A7
	4	1 0E	GND	Vcc	GND	GND	Vcc	GND	20E	30E	GND	Vcc	GND	GND	Vcc	GND	40E
	3	1DIR	GND	Vcc	GND	GND	VCC	GND	2DIR	3DIR	GND	Vcc	GND	GND	Vcc	GND	4DIR
	2	1B0	1B2	1B4	1B6	2B0	2B2	2B4	2B7	3B0	3B2	3B4	3B6	4B0	4B2	4B4	4B7
	1	1B1	1B3	1B5	1B7	2B1	2B3	2B5	2B6	3B1	3B3	3B5	3B7	4B1	4B3	4B5	4B6
		А	в	С	D	Е	F	G	н	J	к	L	М	Ν	Ρ	R	т
Fig 3. Pi	n configura	ation	I														

5.1 Pinning

5.2 Pin description

Table 2. Pin description

Symbol	Ball	Description
nDIR (n = 1 to 4)	A3, H3, J3, T3	direction control
$n\overline{OE}$ (n = 1 to 4)	A4, H4, J4, T4	output enable input (active LOW)
1A[0:7]	A5, A6, B5, B6, C5, C6, D5, D6	input or output
1B[0:7]	A2, A1, B2, B1, C2, C1, D2, D1	input or output
2A[0:7]	E5, E6, F5, F6, G5, G6, H6, H5	input or output
2B[0:7]	E2, E1, F2, F1, G2, G1, H1, H2	input or output
3A[0:7]	J5, J6, K5, K6, L5, L6, M5, M6	input or output
3B[0:7]	J2, J1, K2, K1, L2, L1, M2, M1	input or output
4A[0:7]	N5, N6, P5, P6, R5, R6, T6, T5	input or output
4B[0:7]	N2, N1, P2, P1, R2, R1, T1, T2	input or output
GND	B3, B4, D3, D4, E3, E4, G3, G4, K3, K4, M3, M4, N3, N4, R3, R4	ground (0 V)
V _{CC}	C3, C4, F3, F4, L3, L4, P3, P4	supply voltage



32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

6. Functional description

Table 3.	Function selection ^[1]							
Input nOE		Output	Output					
nOE	nDIR	nAn	nBn					
L	L	A = B	inputs					
L	Н	inputs	B = A					
Н	Х	Z	Z					

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		[3]	200	mA
I _{GND}	ground current		<u>[3]</u> –200	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[4]</u> _	1000	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] All supply and ground pins connected externally to one voltage source.

[4] Above 70 °C the value of P_{tot} derates linearly with 1.8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 2.7 V	-	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	10	ns/V

74LVCH32245A

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32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level	$V_{CC} = 1.2 V$	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
VIL	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35\times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I _I	input leakage current	V _{CC} = 3.6 V; [2] V _I = 5.5 V or GND	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ [2] $V_{O} = 5.5 \text{ V or GND};$	-	0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	40	-	160	μΑ
∆I _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to V_{CC}	-	5.0	-	-	-	pF

74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions		-40	°C to +85	S°C	-40 °C to	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max		
I _{BHL}	bus hold	V_{CC} = 1.65; V_{I} = 0.58 V	[3][4]	10	-	-	10	-	μA
	LOW current	$V_{CC} = 2.3; V_1 = 0.7 V$		30	-	-	25	-	μA
		$V_{CC} = 3.0; V_{I} = 0.8 V$		75	-	-	60	-	μA
I _{BHH} bus hold	V_{CC} = 1.65; V_{I} = 1.07 V	[3][4]	-10	-	-	-10	-	μA	
	HIGH	$V_{CC} = 2.3; V_I = 1.7 V$		-30	-	-	-25	-	μA
	current	$V_{CC} = 3.0; V_{I} = 2.0 V$		-75	-	-	-60	-	μA
I _{BHLO}	bus hold	V _{CC} = 1.95 V	[3][5]	200	-	-	200	-	μA
	LOW overdrive	$V_{CC} = 2.7 V$		300	-	-	300	-	μA
	current	V _{CC} = 3.6 V		500	-	-	500	-	μΑ
I _{BHHO}	bus hold	V _{CC} = 1.95 V	[3][5]	-200	-	-	-200	-	μA
	HIGH overdrive	$V_{CC} = 2.7 V$		-300	-	-	-300	-	μA
	current	$V_{CC} = 3.6 V$		-500	-	-	-500	-	μA

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when $V_1 > V_{CC}$ allowing 5.5 V on the input pin.

[3] Valid for data inputs only. Control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data inputs holds the input below the specified V₁ level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 6</u>.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	-40 °C to	• +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	nAn to nBn; nBn to nAn; see Figure 4	[2]						
delay	V _{CC} = 1.2 V		-	13.0	-	-	-	ns	
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.5	5.2	12.2	1.5	13.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.8	6.0	1.0	6.7	ns
		$V_{CC} = 2.7 V$		1.0	2.7	4.7	1.0	6.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.4	4.5	1.0	6.0	ns
t _{en}	enable time	nOE to nAn, nBn: see Figure 5	[2]						
		$V_{CC} = 1.2 V$		-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.5	5.9	15.0	1.5	16.9	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.3	7.9	1.0	8.8	ns
		$V_{CC} = 2.7 V$		1.5	3.5	6.7	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.7	5.5	1.0	7.0	ns

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{dis}	disable time	nOE to nAn, nBn; see Figure 5	[2]						•
		V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	4.9	13.1	1.5	14.7	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.7	7.1	0.5	7.9	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.3	5.6	1.5	7.0	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per buffer; $V_I = GND$ to V_{CC}	[4]						
	dissipation capacitance	V_{CC} = 1.65 V to 1.95 V		-	11.5	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	15.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 6.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2, 1.8, 2.5 V, 2.7 V, and 3.3 V respectively.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

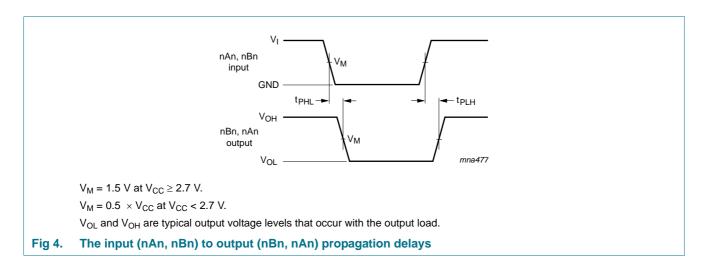
 C_{L} = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

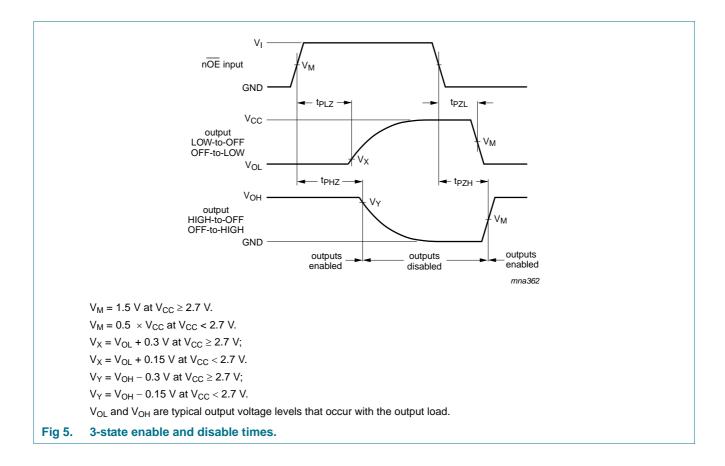
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state



74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

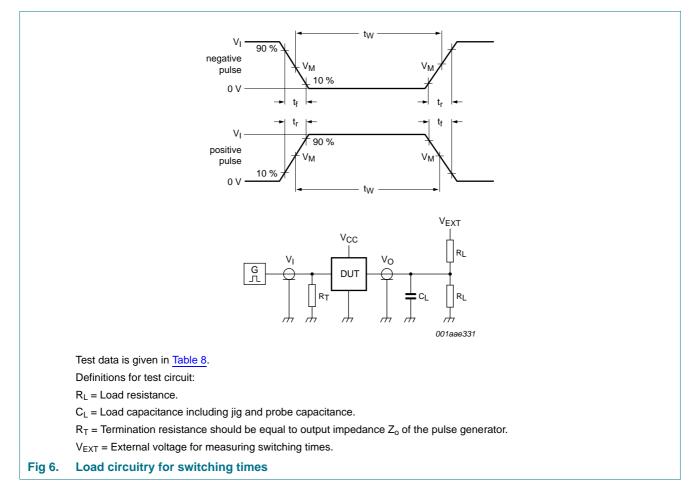


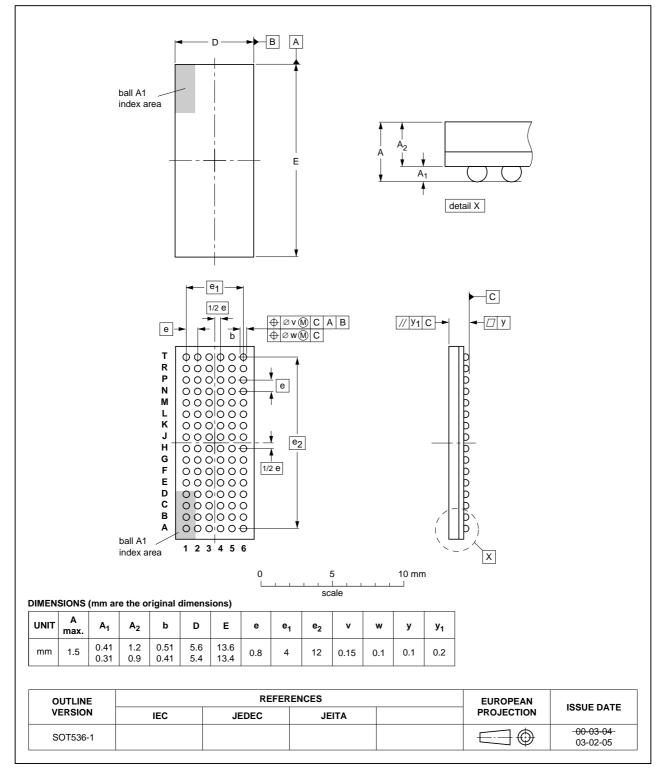
Table 8.	Test data
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Supply voltage	Input		Load		V _{EXT}	V _{EXT}			
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND		
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		

74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

12. Package outline



LFBGA96: plastic low profile fine-pitch ball grid array package; 96 balls; body 13.5 x 5.5 x 1.05 mm SOT536-1

Fig 7. Package outline SOT536-1 (LFBGA96)

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74LVCH32245A

32-bit bus transceiver with direction pin; 5 V tolerant; 3-state

13. Abbreviations

Table 9. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVCH32245A v.5	20111215	Product data sheet	-	74LVCH32245A v.4
Modifications:	 Maximum prop 12.9 ns to 13.8 	• •	/ _{CC} = 1.65 V to 1.95 V	√ at +125 °C changed from
	 Maximum ena to 16.9 ns 	ble time value for $V_{CC} = 1$.65 V to 1.95 V at +1	25 °C changed from 15.8 ns
	 Maximum disa to 14.7 ns 	ble time value for V_{CC} = 1	1.65 V to 1.95 V at + ²	125 °C changed from 13.7 ns
74LVCH32245A v.4	20111109	Product data sheet	-	74LVCH32245A v.3
Modifications:	• Table 4, Table	5, Table 6, Table 7 and Table 7	able 8: values added	for lower voltage ranges.
74LVCH32245A v.3	20070820	Product data sheet	-	74LVCH32245A v.2
74LVCH32245A v.2	20040511	Product specification	-	74LVC_LVCH32245A v.1
74LVC_LVCH32245A v.1	19990901	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design

[2] The term 'short data sheet' is explained in section "Definitions"

The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status [3] information is available on the Internet at URL http://www.nxp.com

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13 of 15

74LVCH32245A

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17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 3
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 4
6	Functional description 5
7	Limiting values 5
8	Recommended operating conditions 5
9	Static characteristics 6
10	Dynamic characteristics 7
11	Waveforms 8
12	Package outline 11
13	Abbreviations 12
14	Revision history 12
15	Legal information 13
15.1	Data sheet status 13
15.2	Definitions
15.3	Disclaimers
15.4	Trademarks 14
16	Contact information 14
17	Contents 15

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